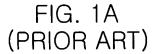
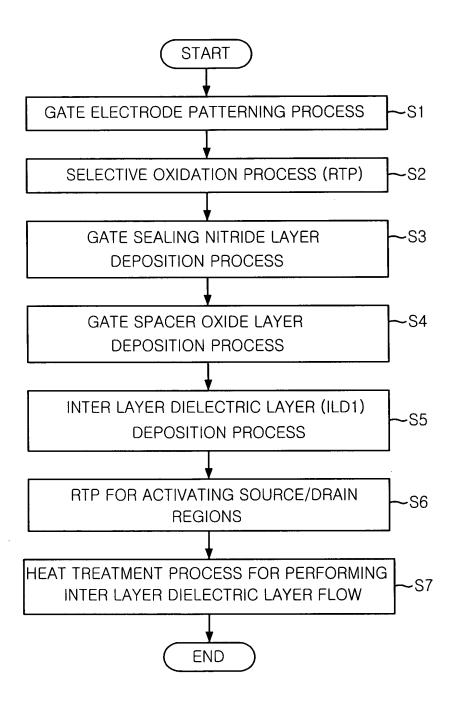
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FIG. 1B (PRIOR ART)

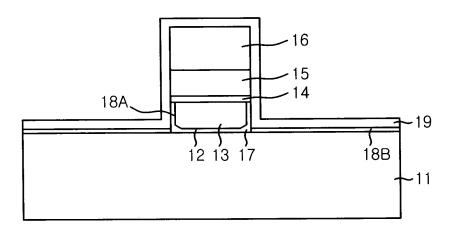
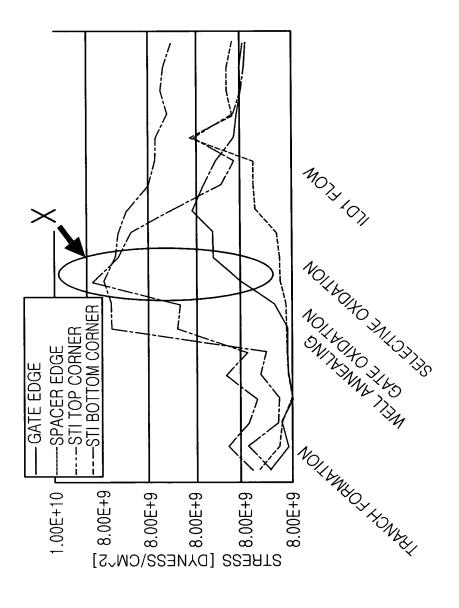


FIG. 2 (PRIOR ART)



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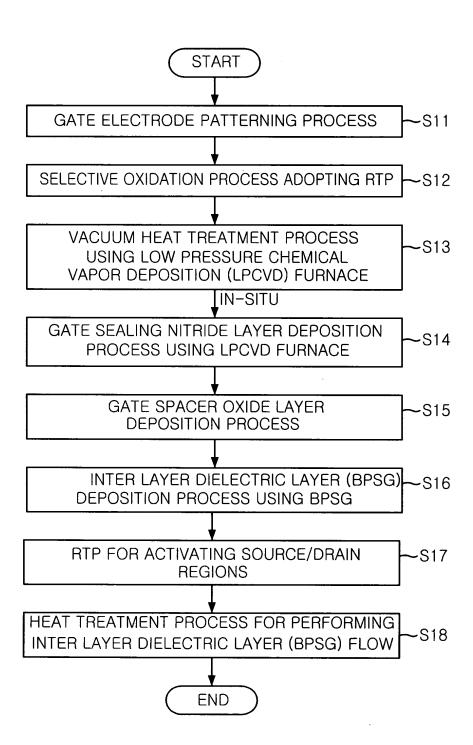
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FIG. 3

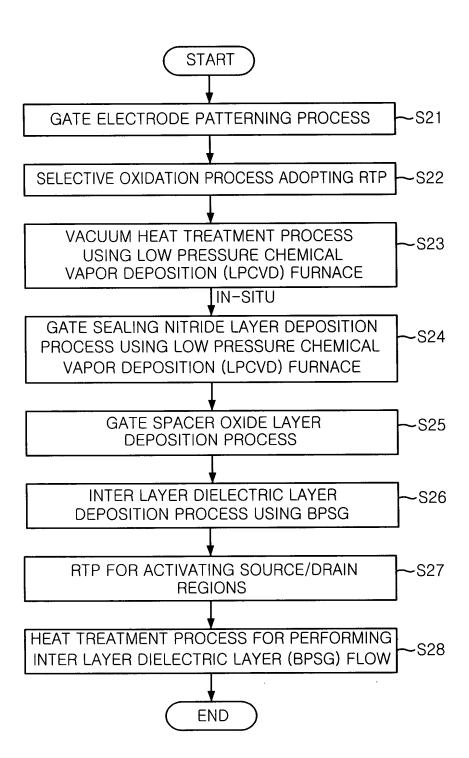


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FIG. 4

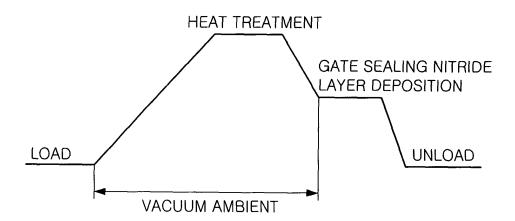


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FIG. 5



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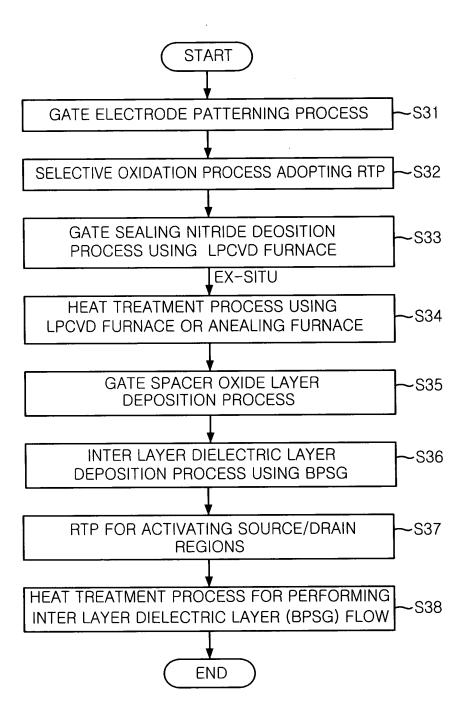
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FIG. 6



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FIG. 7

